

# LQ035Q7DH06

## Advanced TFT-LCD Module 240 × RGB × 320 pixels

(Spec. No.: LCP-05020B)

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## SHARP

MOBILE LIQUID CRYSTAL DISPLAY GROUP SHARP CORPORATION

SPECIFICATION

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Design Center I MOBILE LCD Enterprise Development Center

DEVICE SPECIFICATION FOR

TFT-LCD module

MODEL No. LQ035Q7DH06

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## RECORDS OF REVISION

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This specification applies to LQ035Q7DH06

#### (2) Overview

This module is a color active matrix LCD module incorporating amorphous silicon TFT (Thin Film Transistor), named AD-TFT (Advanced TFT). It is practicable in both transmissive-type and reflection-type modes. It is composed of a color TFT-LCD panel, driver ICs, an FPC, a back light, a touch panel and a back sealed casing. It isn't composed control circuit. Graphics and texts can be displayed on a  $240 \times 3 \times 320$  dots panel with 262,144 colors by supplying.

Optimum view angle is 6 o'clock. An inverted display mode is selective in the vertical or the horizontal direction.

#### (3) Mechanical specifications

Table 1

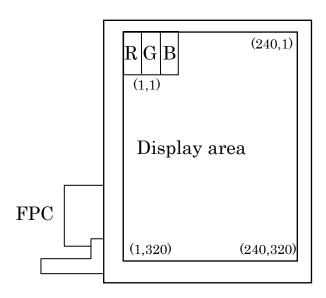
Table 1			
Parameter	Specifications	Units	Remarks
Screen size (Diagonal)	8.9 [3.52"] Diagonal	cm	
Display active area	$53.64(H) \times 71.52(V)$	mm	
Pixel format	$240(H) \times 320(V)$	pixels	
	(1 pixel = R+G+B dots)		
Pixel pitch	$0.2235(H) \times 0.2235(V)$	mm	
Pixel configuration	R,G,B vertical stripe		
Unit outline dimension	$65.0(W) \times 86.2(H) \times 4.0(D)$	mm	[Note3-1]
Mass	45	g	TYP.
Surface hardness	2H		

#### [Note 3-1]

Excluding protrusion, Including FPC cover portion

For detailed measurements and tolerances, please refer to Fig. 1.

#### (4) Pixel configuration





#### 5-1)TFT-LCD panel driving section

Table 2

#### Recommendation CN: FH12A-50S-0.5SH(HIROSE)

Table 2			Recommendation CN: FH12A	
Pin No.	Symbol	I/O	Description	Remarks
1	VL1	I	Power supply for LED (High voltage)	
2	NC	_		
3	VL2	I	Power supply for LED (Low voltage)	
4	VEE	_	Power supply of gate driver(low level)	
5	VSHD	_	Power supply of digital	
6	DGND	_	Ground(digital)	
7	CLS	Ι	Clock signal of gate driver	
8	DGND		Ground(digital)	
9	SPS	Ι	Start signal of gate driver	
10	U/L	Ι	Selection for vertical scanning direction	[Note5-1]
11	MOD	I	Control signal of gate driver	[Note5-2]
12	VDD	_	Power supply of gate driver(high level)	
13	VCOM	I	Common electrode driving signal	
14	DGND	_	Ground(digital)	
15	SPR	I/O	Sampling start signal	
16	DGND	_	Ground(digital)	
17	VSHA	_	Power supply(analog)	
18	LBR	Ι	Selection for horizontal scanning direction	[Note5-3]
19	PS	Ι	Power save signal	
			(Please don't carry out use by "Low" fixation)	
20	REV	Ι	reverse control signal	[Note5-4]
21	DGND	_	Ground(digital)	
22	B5	I	BLUE data signal(MSB)	
23	B4	Ι	BLUE data signal	
24	В3	Ι	BLUE data signal	
25	B2	I	BLUE data signal	
26	B1	Ι	BLUE data signal	
27	В0	I	BLUE data signal(LSB)	
28	LP	I	Data latch signal of source driver	
29	DGND	_	Ground(digital)	
30	SPL	I/O	Sampling start signal	
31	DGND	_	Ground(digital)	
32	DCLK	I	Data sampling clock signal	
33	DGND	_	Ground(digital)	
34	G5	I	GREEN data signal(MSB)	
35	G4	I	GREEN data signal	
36	G3	I	GREEN data signal	
37	G2	I	GREEN data signal	
38	G1	I	GREEN data signal	
39	G0	I	GREEN data signal(LSB)	



Pin No.	Symbol	I/O	Description	Remarks
40	DGND	_	Ground(digital)	
41	R5	I	RED data signal(MSB)	
42	R4	I	RED data signal	
43	R3	I	RED data signal	
44	R2	I	RED data signal	
45	R1	I	RED data signal	
46	R0	I	RED data signal(LSB)	
47	AGND	1	Ground(analog)	
48	COM	0	Produce REV signal with the amplitude of AGND-VSHA	[Note5-4]
49	DGND	1	Ground(digital)	_
50	DGND	_	Ground(digital)	

[Note5-1] Selection for vertical scanning direction

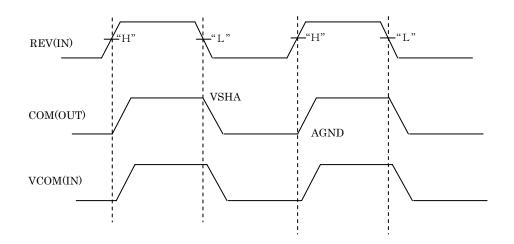
U/L	Scanning direction (Pixel configuration)
Low	Normal scanning (X, 1)
	$\downarrow$
	(X, 320)
High	Inverted scanning (X, 1)
	<b>↑</b>
	(X, 320)

[Note5-2] See section(7-1)-(A) "\*Cautions when you turn on or off the power supply".

[Note5-3] Selection for horizontal scanning direction

LBR	SPL	SPR	Scanning direction (Pixel configuration)
High	Input	Output	Normal scanning $(1,Y) \rightarrow (240,Y)$
Low	Output	Input	Inverted scanning $(1,Y) \leftarrow (240,Y)$

#### [Note5-4]





#### 5-2) Touch panel driving section

Table 3

Recommendation CN	1:	0.4(1.0)9FLH-RSM1-TB	(JST)
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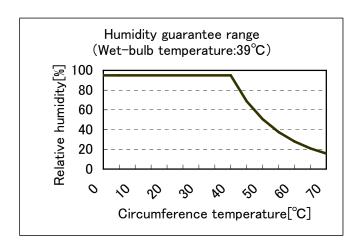
Pin No.	Symbol	I/O	Description	Remark
T1	YU	-	Y (12 o'clock side)	
T2	XL	_	X (right side)	
Т3	YD	_	Y (6 o'clock side)	
T4	XR	_	X (left side)	

#### (6) Absolute Maximum Ratings

Table 4

Parameter	Symbol	Condition	Ratings	Unit	Remark
Power supply(source/Analog)	VSHA	Ta=25℃	-0.3∼+7.0	V	
Power supply(source/Digital)	VSHD	Ta=25℃	-0.3~+7.0	V	
Power supply (gate)	VDD	Ta=25℃	-0.3~+35.0	V	
Power supply (gate)	VDD-VEE	Ta=25°C	-0.3~+35.0	V	
Input voltage (Digital)	VID	Ta=25°C	-0.3~VSHD+0.3	V	[Terminal(1)]
Operating temperature	Торр	_	-10~70	$^{\circ}$ C	[Note6-1]
(panel surface)					
Storage temperature	Tstg	_	-25~70	$^{\circ}$	[Note6-1]

[Note6-1] Humidity: 95%RH Max.(at Ta  $\leq 40^{\circ}$ C). Maximum wet-bulb temperature is less than 39°C (at Ta > 40°C). Condensation of dew must be avoided.



The maximum humidity in the temperature



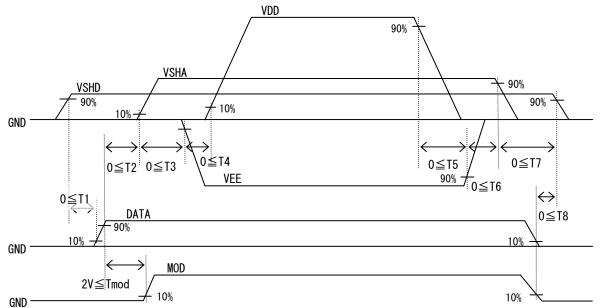
#### 7-1)Recommended operating conditions

#### A) TFT-LCD panel driving section

Table 5 GND=0V

Table 0							GIVD 01
Parameter		Symbol	Min.	Typ.	Max.	Unit	Remarks
Supply voltage for	VSHA	+4.5	+5.0	+5.5	V		
(Analog)							
Supply voltage for	source driver	VSHD	+3.0	+3.3	+3.6	V	
(Digital)							
Supply voltage	High voltage	VDD	+14.5	+15.0	+15.5	V	
for gate driver							
	Low voltage	VEE	-10.5	-10.0	-9.5	V	
Input voltage for Se	ource driver (Low)	VILS	GND	-	0.2VSHD	V	[Note 7-1]
Input voltage for So	ource driver (High)	VIHS	0.8VSHD	-	VSHD	V	[Note 7-1]
Input current for S	ource driver (Low)	IILS	-	-	30	μA	[Note 7-1]
I	1.: (II:-1.)	IIHS1	-	-	30	μA	[Note 7-2]
Input current for Se	ource ariver (High)	IIHS2	-	-	1200	μA	[Note 7-3]
Input voltage for G	ate driver (Low)	VILG	GND	-	0.2VSHD	V	[Note 7-4]
Input voltage for G	VIHG	0.8VSHD	-	VSHD	V	[Note 7-4]	
Input current for G	IILG	-	-	4	μA	[Note 7-4]	
Input current for Gate driver (High)		IIHG	-	-	4	μА	[Note 7-4]
Common electrode	AC component	VCOMAC	-	$\pm 2.5$	$\pm 2.6$	Vp-p	[Note 7-5]
driving signal	DC component	VCOMDC	-0.8	+0.2	+1.2	V	[Note 7-5]

- \*Cautions when you turn on or off the power supply
  - ① Turn on or off the power supply with simultaneously or the following sequence.
  - ② The input signal of "MOD" Terminals (Pin No.11) must be low voltage when turning on the power supply, and it is held until more than double vertical periods after DATA are turned on completely. After then, it must be held high voltage until turning off the power supply. (Connect Pin No.11 terminals to the same signal.)



[Note 7-1] DCLK,SPL,SPR,LBR,LP,PS,REV,R0~R5,G0~G5 and B0~B5 terminals are applied.

[Note 7-2] DCLK,SPL,SPR,LBR,LP,REV,R0 $\sim$ R5,G0 $\sim$ G5 and B0 $\sim$ B5 terminals are applied.

[Note 7-3] PS terminal is applied.

[Note 7-4] MOD, CLS, SPS and U/L terminals are applied.

[Note 7-5] VCOMAC should be alternated on VCOMDC every 1 horizontal period and 1 vertical period. VCOMDC bias is adjusted so as to minimize flicker or maximum contrast every each module.

#### B) Back light driving section

Table 6 Ta= $25^{\circ}$ C

Parameter	Symbol	MIN	TYP	MAX	Units	Remarks terminal
LED voltage	$V_{\rm L}$		19.2	21.6	V	
LED current	IL	_	20	22	mA	
Power consumption	WL	_	0.384	_	W	[Note 7-6]

[Note 7-6] Calculated reference value(IL×VL)

7-2) Timing Characteristics of input signals

Table 7 AC Characteristics (1)

(VSHA=+5V, VSHD=+3.3V, Ta=25°C)

Paramete	er	Symbol	Min.	Тур.	Max.	Unit	Remark
Clock fre	quency of source driver	fCK	4.5	_	6.8	MHz	
	Rising time of clock	Ter	_	_	20	ns	
	Falling time of clock	Tef	_	_	20	ns	DCLK
	Pulse width (High level)	Tewh	40	_	_	ns	
	Pulse width (Low level)	Tcwl	40	_	_	ns	
	Frequency of start pulse	fsp	16.5	_	28	kHz	
	Setup time of start pulse	Tsusp	15	_	_	ns	SPL,SPR
C	Hold time of start pulse	Thsp	10	_	_	ns	
Source	Pulse width of start pulse	Twsp	_	_	1.5/fck	ns	[Note 7-7]
driver	Setup time of latch pulse	Tsulp	20	_	_	ns	
	Hold time of latch pulse	Thlp	20	_	_	ns	LP
	Pulse width of latch pulse	Twlp	60	_	_	ns	
	Setup time of PS	Tsups	0	_	_	μs	
	Setup time of PS	Tsulps	1	_	_	μs	DG.
	Hold time of PS	Thps	0	_	_	μs	PS
	Hold time of PS	Thlps	30	_	_	ns	
Set up ti	me of data	Tsud	15	_	_	ns	R0~R5,G0~G5
Hold tim	e of data	Thd	10	_	_	ns	,B0∼B5
	Clock frequency	fcls	16.5	_	28	kHz	
	Pulse width of clock(Low)	Twlcls	5	_	(1/fcls)-30	μs	
	Pulse width of clock(High)	Twhcls	30	_	_	μs	
	Rising time of clock	Trcls	_	_	100	ns	CLS
	Falling time of clock	Tfcls	_	_	100	ns	
Gate	Setup time of clock	Tsucls	3	_	_	μs	
driver	Hold time of clock	Thels	0	_	_	μs	
	Frequency of start pulse	fsps	58	_	86	Hz	
	Setup time of start pulse	Tsusps	100	_	_	ns	
	Hold time of start pulse	Thsps	300	_	_	ns	SPS
Ī	Rising time of start pulse	Trsps	_	_	100	ns	
	Falling time of start pulse	Tfsps	_	_	100	ns	
Vcom	Setup time of Vcom	Tsuvcom	0	_	_	μs	Vcom
	Hold time of Vcom	Thycom	1	_	_	μs	

[Note 7-7] There must be only one up-edge of DCLK (includes Tsusp and Thsp time) in the period of SPL="Hi".

## **SHARP**

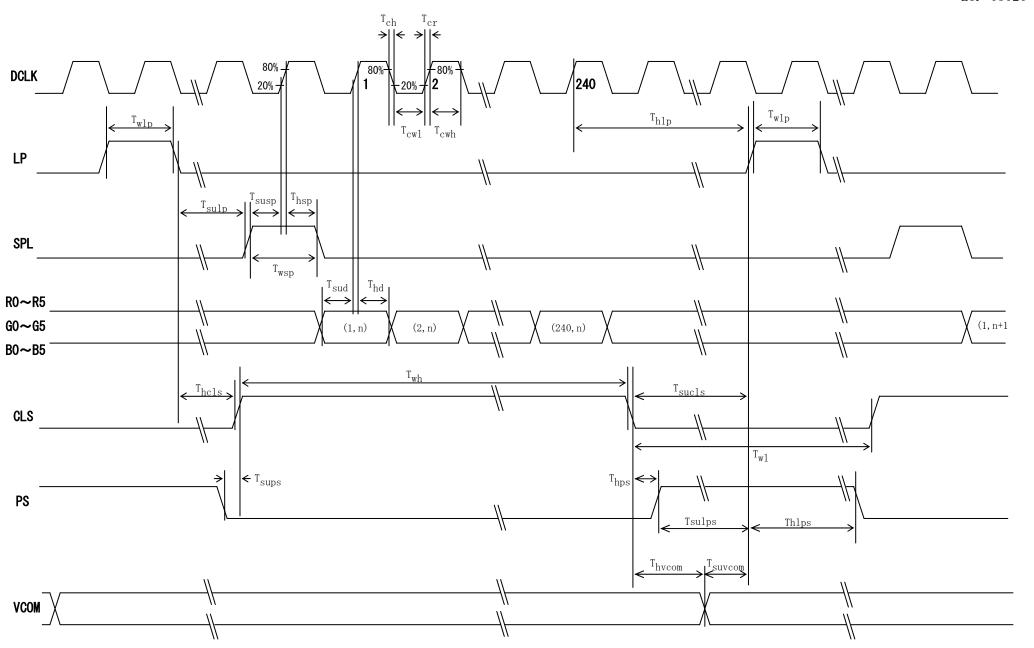


Fig.(a) Horizontal timing chart

### **SHARP**

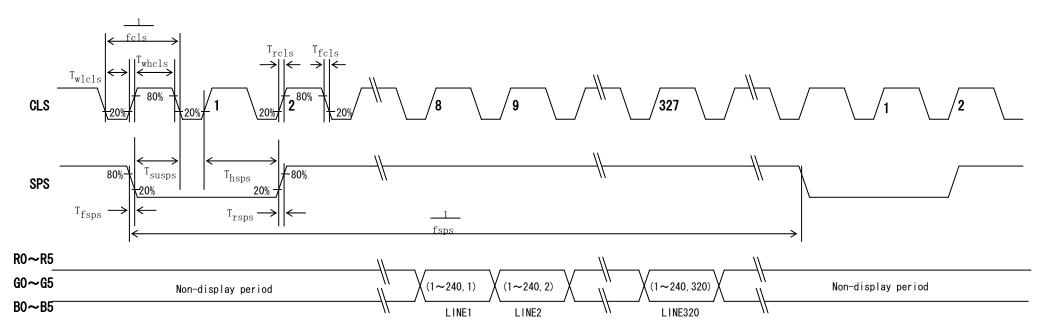


Fig.(b) Vertical timing chart



7-3)Power consumption

 $Measurement\ condition: SPS=60Hz, CLS=15.73kHz, SPL=15.73kHz, DCLK=6.3MHz$ 

The term of PS="Lo" in one horizontal period  $\cdots$  37 $\mu$ sec(234DCLK)

 $Ta=25^{\circ}C$ 

Table 9 when normal scan mode

Param	eter	Sym	Conditions	MIN	TYP	MAX	Unit	Remarks
Source	Analog	ISHA	VSHA=+5.0V	_	3.0	6.0	mA	[Note 7-8]
current	Digital	ISHD	VSHD=+3.3V	_	1.5	3.0	mA	[Note 7-8]
Gate	High	IDD	VDD=+15.0V	_	0.05	0.10	mA	[Note 7-9]
current	Low	IEE	VEE=-10.0V	_	-0.05	-0.10	mA	[Note 7-9]

[Note 7-8] Vertical stripe pattern alternating 21 gray scale (GS21) with 42 gray scale (GS42) every 1 dot.

[Note 7-9] 64-Gray-bar vertical pattern (GS0  $\,\sim\,$  GS63 for horizontal way)



(8) Input Signals, Basic Display Color and Gray Scale of Each Color

Table 10

	Table 10	l'able 10																		
	Colors &						Da	ta sig	gnal											
	Gray scale	Gray	R0	R1	R2	R3	R4	R5	G0	G1	G2	G3	G4	G5	В0	B1	B2	В3	B4	B5
		Scale																		
	Black	_	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	_	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
В	Green	_	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
$\operatorname{asic}$	Cyan	_	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
Basic color	Red	_	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
r	Magenta	_	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow		1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	_	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	仓	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale of red	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
$^{7}\mathrm{Scs}$	仓	<b>←</b>				l					1	l					1	l		
ale o	Û	$\rightarrow$	<b>\</b>				<b>V</b>				<b>V</b>									
frec	Brighter	GS61	1	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Û	GS62	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red	GS63	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
G	仓	GS1	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
$\mathbf{ray}$	Darker	GS2	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
Gray Scale	仓	$\rightarrow$				l					1	<b>\</b>					1	V		
	Û	$\rightarrow$			V	l			↓						1	l				
of green	Brighter	GS61	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0
n	Û	GS62	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0
	Green	GS63	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Û	GS1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
я̀rау	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
Sca	⇧	<b>\</b>				<b>-</b>						<b>-</b>						<b>-</b>		
Gray Scale of bleu	Û	<b>→</b>			V				, ↓							1	V			
f ble	Brighter	GS61	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1
n	Û	GS62	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
	Bleu	GS63	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

0:Low level voltage

Each basic color can be displayed in 64 gray scales from 6 bit data signals. According to the combination of total 18 bit data signals, the 262,144-color display can be achieved on the screen.

<sup>1 :</sup>High level voltage



#### (9) Optical characteristics

#### 9-1)Not driving the Back light condition

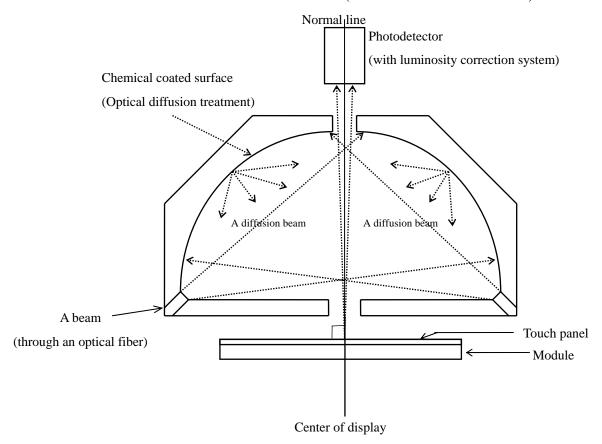
Table 11

(VSHA=+5V, VSHD=+3.3V, VDD=+15V, VEE=-10V, Ta=25°C)

					,	, .	, .	/ /
Parameter		Symbol	Condition	Min	Тур	Max	Unit	Remarks
Viewing ar	ngle	θ21,22		35	50	-	degree	[Note 9-1,2]
range	range		CR≥1.5	35	50	1	degree	
		θ12		35	50	1	degree	
Contrast ratio		CRmax	θ =0°	2	3	ı		[Note 9-2,4]
Response	Rise	τr		-	30	60	ms	[Note 9-3]
time	Fall	τd	0.00	-	50	100	ms	
White chromaticity		X	$\theta = 0^{\circ}$	0.27	0.32	0.37		[Note 9-4]
		у		0.30	0.35	0.40		
Reflection ratio		R	θ =0°	2.5	4	-	%	[Note 9-5]

<sup>\*</sup> The measuring method of the optical characteristics is shown by the following figure.

<sup>\*</sup> A measurement device is Otsuka luminance meter LCD5000.(With the diffusion reflection unit.)



Measuring method (a) for optical characteristics



#### 9-2)Driving the Back light condition

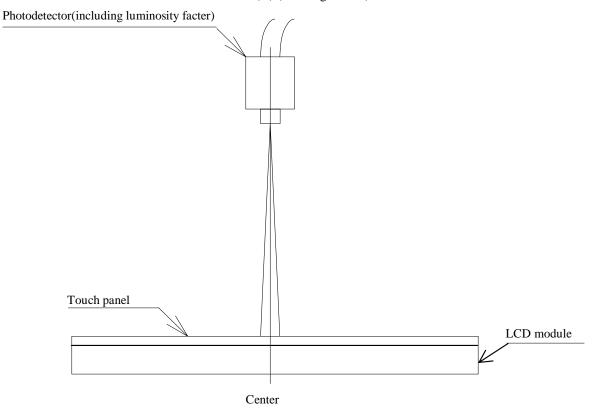
Table 12

(VSHA=+5V, VSHD=+3.3V, VDD=+15V, VEE=-10V , $Ta=25^{\circ}C$ )

14010 12				(161111 :	or, reme	10.01, 1	BB 1101,	1 HH 10 1 ,1 a 20 C/	
Parameter		Symbol	Condition	Min	Тур	Max	Unit	Remarks	
Viewing an	gle	θ21,22		30	40	-	degree	[Note 9-1,2,6]	
range	range		CR≥2	40	50	-	degree		
		θ12		30	40	-	degree		
Contrast ratio		Crmax	$\theta = 0^{\circ}$	50	80	-		[Note 9-2]	
Response	Rise	τr		-	30	60	ms	[Note 9-3]	
time	Fall	τd		-	50	100	ms		
White chromaticity		X		0.25	0.30	0.35			
		у		0.28	0.33	0.38			
Brightness		Y	$\theta = 0^{\circ}$	165	225	-	cd/m <sup>2</sup>	IL=20mA	
LED life time		LL	IL=20mA	-	_	-	hour	[Note 9-7]	

<sup>\*</sup> The measuring method of the optical characteristics is shown by the following figure.

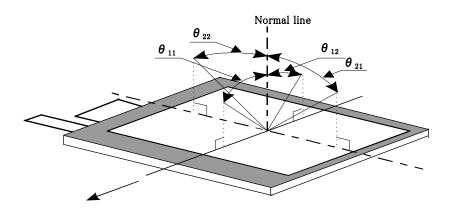
<sup>\*</sup> A measurement device is TOPCON luminance meter BM-5(A).(Viewing cone 1)



Measuring method (c) for optical characteristics



[Note 9-1] Viewing angle range is defined as follows.



6 o'clock direction

#### Definition for viewing angle

[Note 9-2] Definition of contrast ratio:

The contrast ratio is defined as follows:

Photodetecter output with all pixels white(GS63)

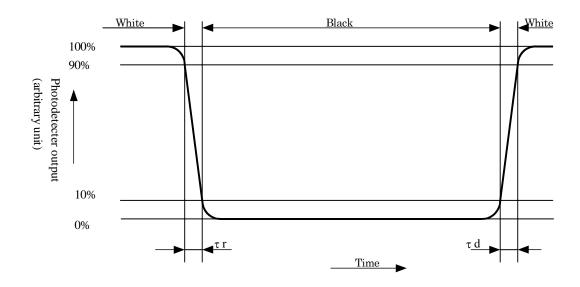
Contrast ratio(CR)=

Photodetecter output with all pixels black(GS0)

VCOMAC=5.0Vp-p

[Note 9-3] Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".





[Note 9-4] A measurement device is Minolta CM-2002.

[Note 9-5] Definition of reflection ratio

Reflection ratio =

Light detected level of the reflection by the LCD module

Light detected level of the reflection by the standard white board

[Note 9-6] A measurement device is ELDIM EZContrast

[Note 9-7] This is the reference value. The White-LED life time is defind as a time when brightness not to become under 50% of the original value(at Ta=25°C)

#### (10) Touch panel characteristics

#### Table 13

able 15					
Parameter	Min.	Тур.	Max.	Unit	Remark
Input voltage	_	5.0	7.0	V	
Resistor between terminals(XL-XR)	200	_	640	Ω	Provisional
Resistor between terminals(YU-YD)	150	_	550	Ω	specification
Line linearity(X direction)	_	_	1.5	%	
Line linearity(Y direction)	_	_	1.5	%	
Insuration resistance	20	_	_	ΜΩ	at DC25V
Minimum tension for detecting	_	_	0.79	N	

#### (11) Display quality

The display quality of the color TFT-LCD module shall be in compliance with the Incoming Inspection Standards for TFT-LCD..

#### (12) Mechanical characteristics

12-1) External appearance

See Fig. 1

12-2) FPC (for LCD panel) characteristics

(1)Specific connector

FH12A-50S-0.5SH (HIROSE)

(2) Bending endurance of the bending slits portion

No line of the FPC is broken for the bending test (Bending radius=0.6mm and angle=90°) in 30 cycles.

#### 12-3) Design guidance for touchpanel(T/P)

- 12-3-1) Example of housing design
  - (1)If a consumer will put a palm on housing in normal usage, care should be taken as follows.
  - (2) Keep the gap, for example 0.3 to 0.7mm, between bezel edge and T/P surface.

The reason is to avoid the bezel edge from contacting T/P surface that may cause a "short" with bottom layer. (See Fig.2)

- (3)Insertion a cushion material is recommended.
- (4) The cushion material should be limited just on the busbar insulation paste area.

If it is over the transparent insulation paste area, a "short" may be occurred.

(5) There is one where a resistance film is left in the T/P part of the end of the pole.

Design to keep insulation from the perimeter to prevent from mis-operation and so on.



- 12-3-2) Mounting on display and housing bezel
  - (1)In all cases, the T/P should be supported from the backside of the Plastic.
  - (2)Do not to use an adhesive-tape to bond it on the front of T/P and hang it to the housing bezel.
  - (3)Never expand the T/P top layer (PET-film) like a balloon by internal air pressure.

The life of the T/P will be extremely short.

- (4)Top layer, PET, dimension is changing with environmental temperature and humidity. Avoid a stress from housing bezel to top layer, because it may cause "waving".
- (5) The input to the Touchpanel sometimes distorts touch panel itself.

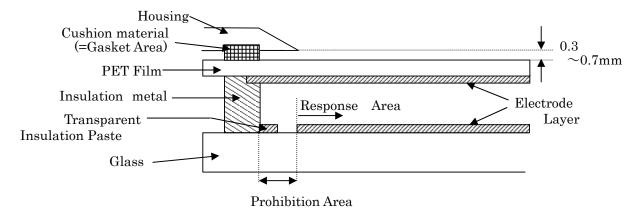


Fig.2



#### (13) Handling Precautions

#### 13-1) Insertion and taking out of FPCs

Be sure insert and take out of the FPC into the connector of the set after turning off the power supply on the set side.

#### 13-2) Handling of FPCs

The FPC for LCD panel shall be bent only slit portion. The bending slit shall be bent uniformly on the whole slit portion with bending radius larger than 0.6mm, and only inner side (back side of the module). Don't bend it outer side (display surface side).

Don't give the FPCs too large force, for example, hanging the module with holding FPC.

#### 13-3) Installation of the module

On mounting the module, be sure to fix the module on the same plane. Taking care not to warp or twist the module.

#### 13-4) Precautions when mounting

- (1) If water droplets and oil attaches to it for a long time, discoloration and staining occurs. Wipe them off immediately.
- (2) Glass is used for the TFT-LCD panel. If it is dropped or bumped against a hard object, it may be broken. Handle it with sufficient care.
- (3) As the CMOS IC is used in this module, pay attention to static electricity when handling it. Take a measure for grounding on the human body.

#### 13-5) Others

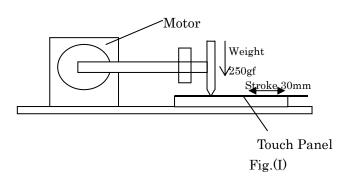
- (1) The liquid-crystal is deteriorated by ultraviolet rays. Do not leave it in direct sunlight and strong ultraviolet rays for many hours.
- (2) If it is kept at a temperature below the rated storage temperature, it becomes coagulated and the panel may be broken. Also, if it is kept at a temperature above the rated storage temperature, it becomes isotropic liquid and does not return to its original state. Therefore, it is desirable to keep it at room temperature as much as possible.
- (3) If the LCD breaks, don't put internal liquid crystal into the mouth. When the liquid crystal sticks to the hands, feet and clothes, wash it out immediately.
- (4) Wipe off water drop or finger grease immediately. Long contact with water may cause discoloration or spots.
- (5) Observe general precautions for all electronic components.
- (6) VCOM must be adjusted on condition of your final product. No adjustment causes the deterioration for display quality.
- (7) Static image should not be displayed more than 5 minutes in order to prevent from occurrence of residual image.
- (8) If local pressure joins T/P surface for a long time, it will become the cause of generating of Newton's ring.



#### (14) Reliability Test Conditions for TFT-LCD Module

Table 14

No.	Test items	ble 14  Test conditions							
1	High temperature storage test	Ta=+70℃ 240h							
2	Low temperature storage test	Ta=-25°C 240h							
3	High temperature and high humidity operating test								
4		Tp=+70°C 240h							
5	Low temperature operating test	Tp=-10°C 240h							
6	Electro static discharge test	$\pm 200 \text{V} \cdot 200 \text{pF}(0\Omega)$ to Terminals(Contact) (1 time for each terminals) $\pm 8 \text{kV} \cdot 150 \text{pF}(330\Omega)$ to Housing bezel or TP(Contact) $\pm 15 \text{kV} \cdot 150 \text{pF}(330\Omega)$ to Housing bezel or TP(in Air)							
7	Shock tset	$980 \text{ m/s}^2$ , 6 ms $\pm \text{X}, \pm \text{Y}, \pm \text{Z}$ 3 times for each direction (JIS C0041, A-7 Condition C)							
8	Vibration test	Frequency range: 10Hz~55Hz  Stroke: 1.5 mm Sweep: 10Hz~55Hz  X,Y,Z 2 hours for each direction (total 6 hours)  (JIS C0040,A-10 Condition A)							
9	Heat shock test	Ta=-25°C $\sim$ +70°C / 5 cycles (1h) (1h)							
10	Point activation test (Touch panel)	Hit it 1,000,000 times with a silicon rubber of R8 HS 60. Hitting force :2.4N Hitting speed : 3 times per second							
11	Writing friction resistance test (Touch panel)	Slide Pen 100,000 times under following conditions: Pen: 0.8Rmm Polyacetal stylus Load: 2.4N Speed: 3 strokes per second Stroke: 30mm Testing apparatus: shown in Fig (I)							
12	FPC Bending Test	Bending 30 times by bending radius R0.6mm and angle=90°  (LCD FPC)  Bending 10 times by bending radius R1.0mm (T/P FPC)							





[Note] Ta = Ambient temperature, Tp = Panel temperature

[Check items]

(a)Test No.1~9

In the standard condition, there shall be no practical problems that may affect the display function.

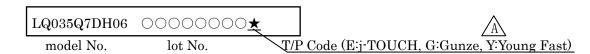
(b)Test No.10~No.11

The measurements after the tests are satisfied (10)-Table 13 (Touch panel characteristics)

#### (15) Others

15-1) Indication of lot number

The lot number is shown on a label. Attached location is shown in Fig.1 (Outline Dimensions). Indicated contents of the label



15-2) Used Regulation of Chemical Substances Breaking Ozone Stratum

Substances with the object of regulating: CFCS, Carbon tetrachloride, Halon

1,1,1-Trichloro ethane (Methyl chloroform)

- (a) This LCD module, Constructed part and Parts don't contain the above substances.
- (b) This LCD module, Constructed part and Parts don't contain the above substances in processes of manufacture.
- 15-3) If some problems arise about mentioned items in this document and other items, the user of the TFT-LCD module and Sharp will cooperate and make efforts to solve the problems with mutual respect and good will.
- (16) Forwarding form(see Fig.3 Package Form)
- (17) Piling number of cartons: Max 8
- (18) Package quantity in one cartons: 100pcs
- (19) Carton size:  $575 \text{mm} \times 332 \text{mm} \times 209 \text{mm}$
- (20) Total mass of 1 carton filled with full modules: 8000g

Conditions for storage.

Environment

(1)Temperature  $0 \sim 40^{\circ}$ C

(2) Humidity : 60%RH or less (at 40°C)

No dew condensation at low temperature and high humidity.

(3)Atmosphere : Harmful gas, such as acid or alkali which bites electronic

components and/or wires, must not be detected.

(4)Period : about 3 months

(5)Opening of the package: In order to prevent the LCD module from breakdown by

electrostatic charges, please control the room humidity over 50%RH and open the package taking sufficient countermeasures against electrostatic charges, such as

earth, etc.

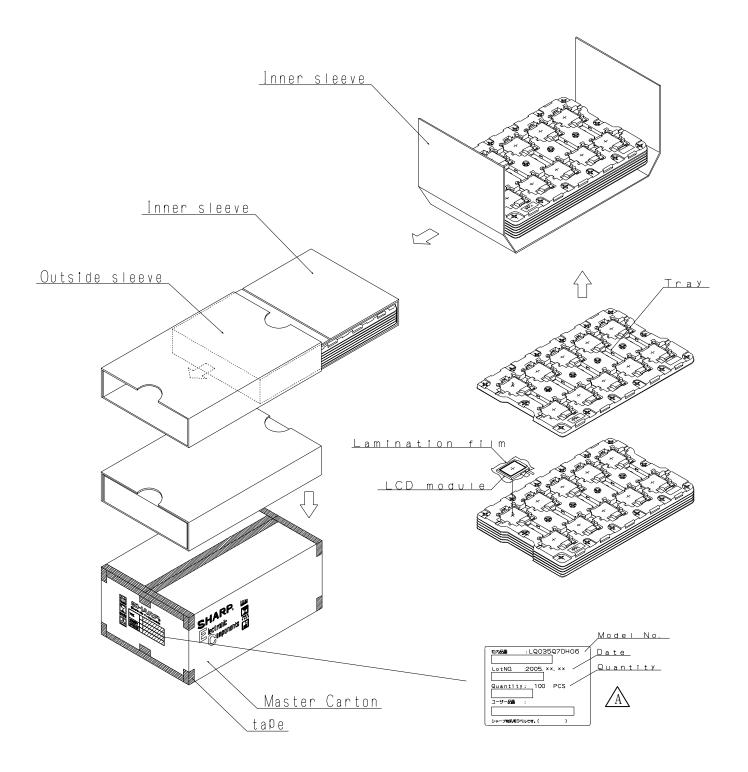
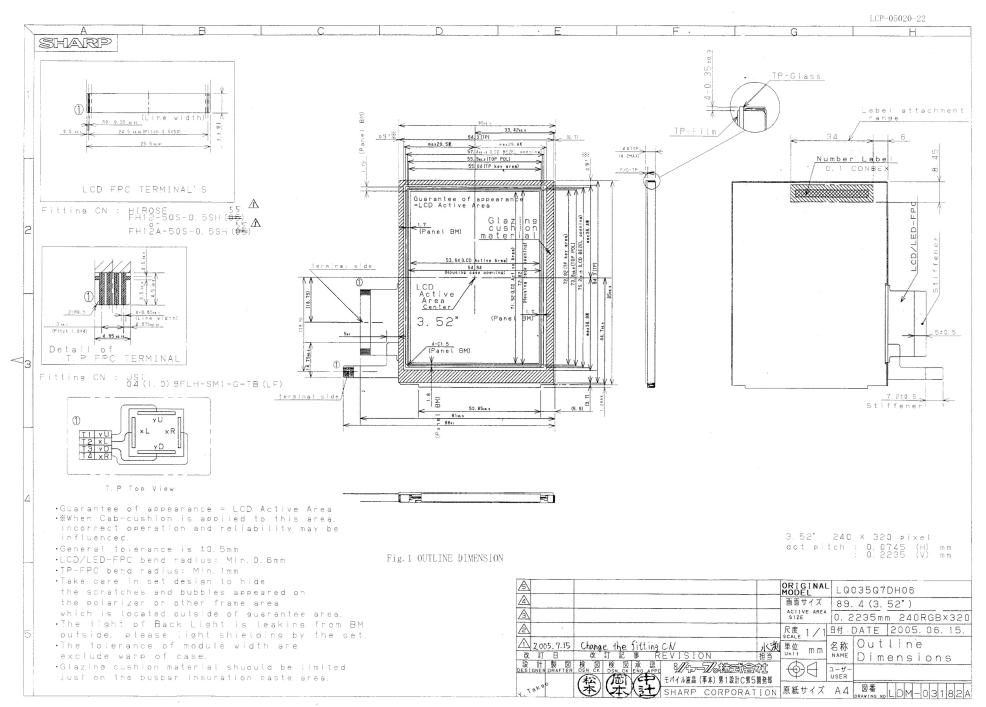


Fig. 3 Forwarding form



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